

N-Ch and P-Ch Fast Switching MOSFET

$V_{DS}=60V$, $I_D=4.8A$, $R_{DS(ON)}=32m\Omega$

$V_{DS}=-60V$, $I_D=-3.7A$, $R_{DS(ON)}=70m\Omega$

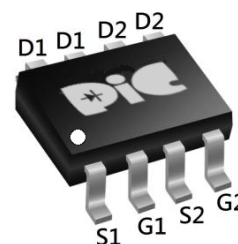
➤ General Description

This PAC69TJ01J N&P Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent $R_{ds(On)}$ performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➤ Feature

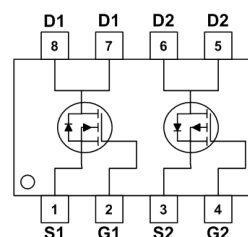
- Super Low Gate Charge
- 100% EAS Guaranteed
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

➤ SOP-8



➤ Application

- Notebook CPU Core-High-Side Switch



➤ Absolute Maximum Ratings

Parameter	Symbol	Rating		Units
		N-Channel	P-Channel	
Drain-Source Voltage	V_{DS}	60	-60	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current, $V_{GS} @ 10V^1$	$I_D @ T_A=25^\circ C$	4.8	-3.7	A
Continuous Drain Current, $V_{GS} @ 10V^1$	$I_D @ T_A=70^\circ C$	3.8	-3	A
Pulsed Drain Current ²	I_{DM}	9.6	-7.5	A
Single Pulse Avalanche Energy ³	EAS	25.5	35.3	mJ
Avalanche Current	I_{AS}	22.6	-26.6	A
Total Power Dissipation ⁴	$P_D @ T_A=25^\circ C$	1.5	1.5	W
Storage Temperature Range	T_{STG}	-55 to 150	-55 to 150	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to 150	-55 to 150	$^\circ C$
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	---	85	$^\circ C/W$
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	36	$^\circ C/W$

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➤ N-Channel Electrical Characteristics ($T_J=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$, $I_D=250\mu A$	60	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ C$, $I_D=1mA$	---	0.063	---	V/ $^\circ C$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	$V_{GS}=10V$, $I_D=4A$	---	---	32	m Ω
		$V_{GS}=4.5V$, $I_D=2A$	---	---	38	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1.2	---	2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	-5.24	---	mV/ $^\circ C$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=48V$, $V_{GS}=0V$, $T_J=25^\circ C$	---	---	1	uA
		$V_{DS}=48V$, $V_{GS}=0V$, $T_J=55^\circ C$	---	---	5	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{DS}=5V$, $I_D=4A$	---	21	---	S
Gate Resistance	R_g	$V_{DS}=0V$, $V_{GS}=0V$, $f=1MHz$	---	3.2	---	Ω
Total Gate Charge (4.5V)	Q_g	$V_{DS}=48V$, $V_{GS}=4.5V$, $I_D=4A$	---	12.6	---	nC
Gate-Source Charge	Q_{gs}		---	3.2	---	
Gate-Drain Charge	Q_{gd}		---	6.3	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=30V$, $V_{GS}=10V$, $R_G=3.3\Omega$, $I_D=4A$	---	8	---	ns
Rise Time	T_r		---	14.2	---	
Turn-Off Delay Time	$T_{d(off)}$		---	24.4	---	
Fall Time	T_f		---	4.6	---	
Input Capacitance	C_{iss}	$V_{DS}=15V$, $V_{GS}=0V$, $f=1MHz$	---	1378	---	pF
Output Capacitance	C_{oss}		---	86	---	
Reverse Transfer Capacitance	C_{rss}		---	64	---	

➤ Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current ^{1,5}	I_S	$V_G=V_D=0V$, Force Current	---	---	4.8	A
Pulsed Source Current ^{2,5}	I_{SM}		---	---	9.6	A
Diode Forward Voltage ²	V_{SD}	$V_{GS}=0V$, $I_S=1A$, $T_J=25^\circ C$	---	---	1.2	V

Note :

1.Pulse width limited by maximum junction temperature.

2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

3.The EAS data shows Max. rating . The test condition is $V_{DD}=25V$, $V_{GS}=10V$, $L=0.1mH$, $I_{AS}=22.6A$

4.Ensure that the channel temperature does not exceed $150^\circ C$.

5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

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➤ P-Channel Electrical Characteristics ($T_J=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$, $I_D=-250\mu A$	-60	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ C$, $I_D=-1mA$	---	-0.03	---	V/ $^\circ C$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	$V_{GS}=-10V$, $I_D=-3A$	---	---	70	$m\Omega$
		$V_{GS}=-4.5V$, $I_D=-2A$	---	---	105	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$, $I_D=-250\mu A$	-1.2	---	-2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	4.56	---	mV/ $^\circ C$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-48V$, $V_{GS}=0V$, $T_J=25^\circ C$	---	---	1	μA
		$V_{DS}=-48V$, $V_{GS}=0V$, $T_J=55^\circ C$	---	---	5	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{DS}=-5V$, $I_D=-3A$	---	15	---	S
Gate Resistance	R_g	$V_{DS}=0V$, $V_{GS}=0V$, $f=1MHz$	---	13.5	---	Ω
Total Gate Charge (-4.5V)	Q_g	$V_{DS}=-48V$, $V_{GS}=-4.5V$, $I_D=-3A$	---	9.86	---	nC
Gate-Source Charge	Q_{gs}		---	3.1	---	
Gate-Drain Charge	Q_{gd}		---	2.95	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-15V$, $V_{GS}=-10V$, $R_G=3.3\Omega$, $I_D=-1A$	---	28.8	---	ns
Rise Time	T_r		---	19.8	---	
Turn-Off Delay Time	$T_{d(off)}$		---	60.8	---	
Fall Time	T_f		---	7.2	---	
Input Capacitance	C_{iss}	$V_{DS}=-15V$, $V_{GS}=0V$, $f=1MHz$	---	1447	---	pF
Output Capacitance	C_{oss}		---	97.3	---	
Reverse Transfer Capacitance	C_{rss}		---	70	---	

➤ Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current ^{1,5}	I_S	$V_G=V_D=0V$, Force Current	---	---	-3.7	A
Pulsed Source Current ^{2,5}	I_{SM}		---	---	-7.5	A
Diode Forward Voltage ²	V_{SD}	$V_{GS}=0V$, $I_S=-1A$, $T_J=25^\circ C$	---	---	-1.2	V

Note :

1.Pulse width limited by maximum junction temperature.

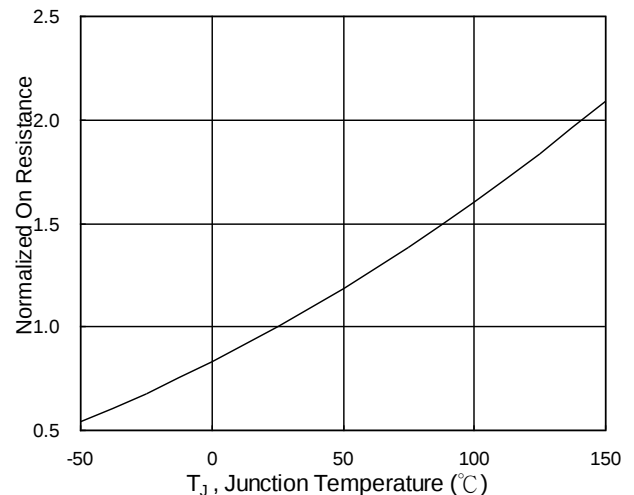
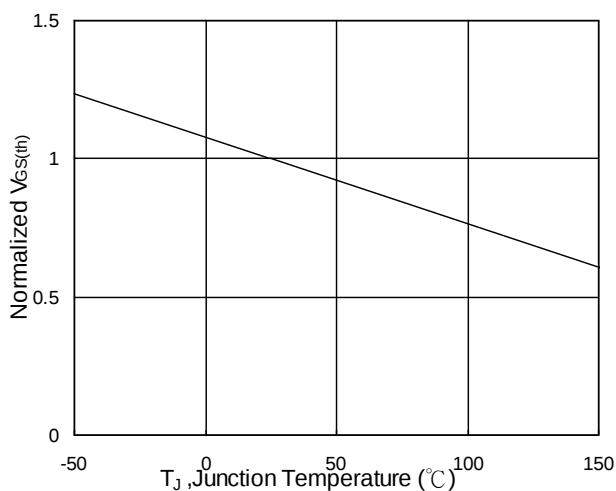
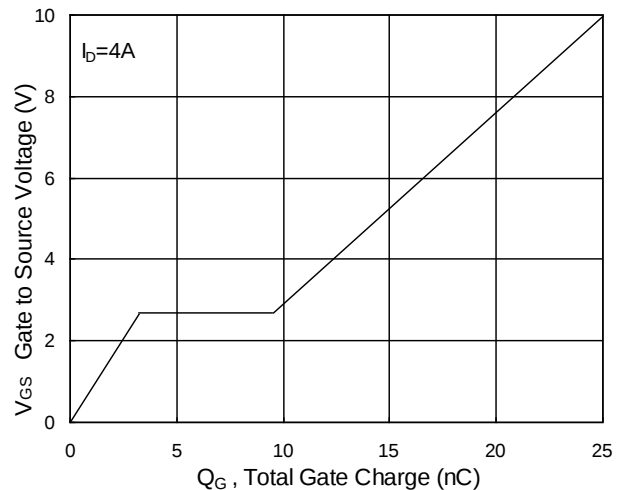
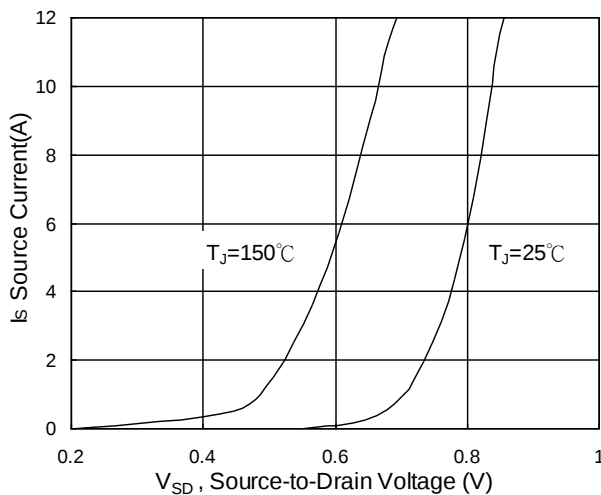
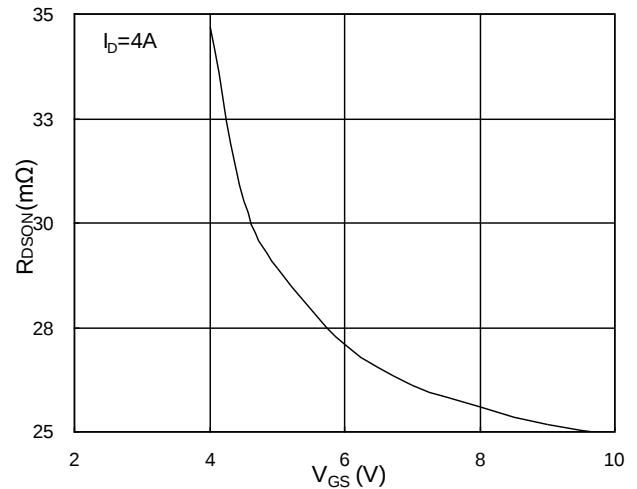
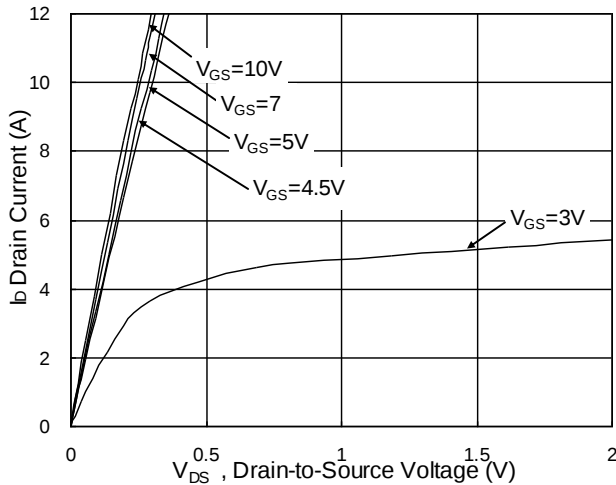
2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

3.The EAS data shows Max. rating . The test condition is $V_{DD}=-25V$, $V_{GS}=-10V$, $L=0.1mH$, $I_{AS}=-26.6A$

4.Ensure that the channel temperature does not exceed $150^\circ C$.

5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

➤ N-Channel Typical Characteristics



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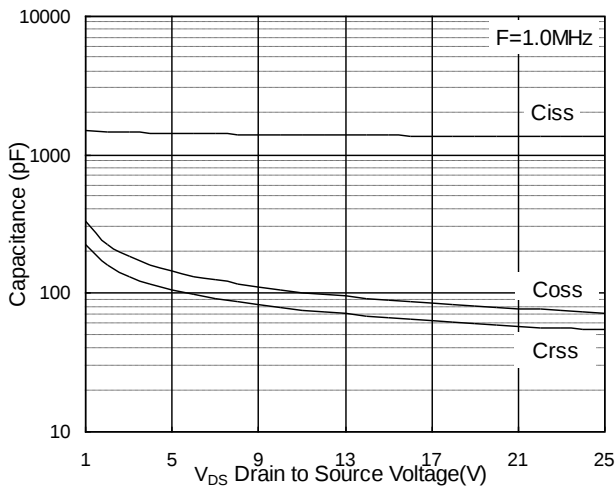


Fig.7 Capacitance

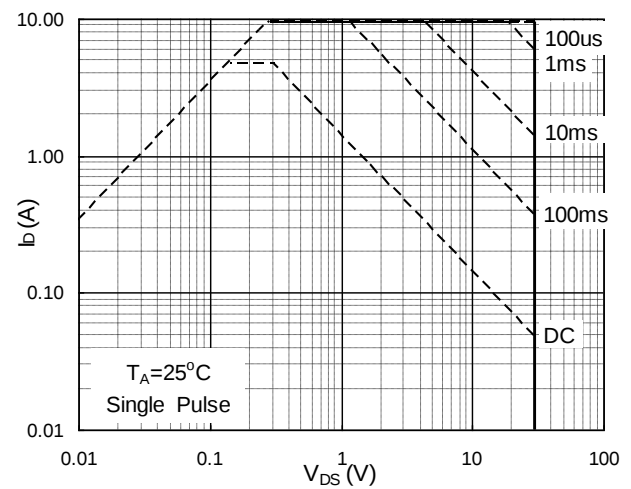


Fig.8 Safe Operating Area

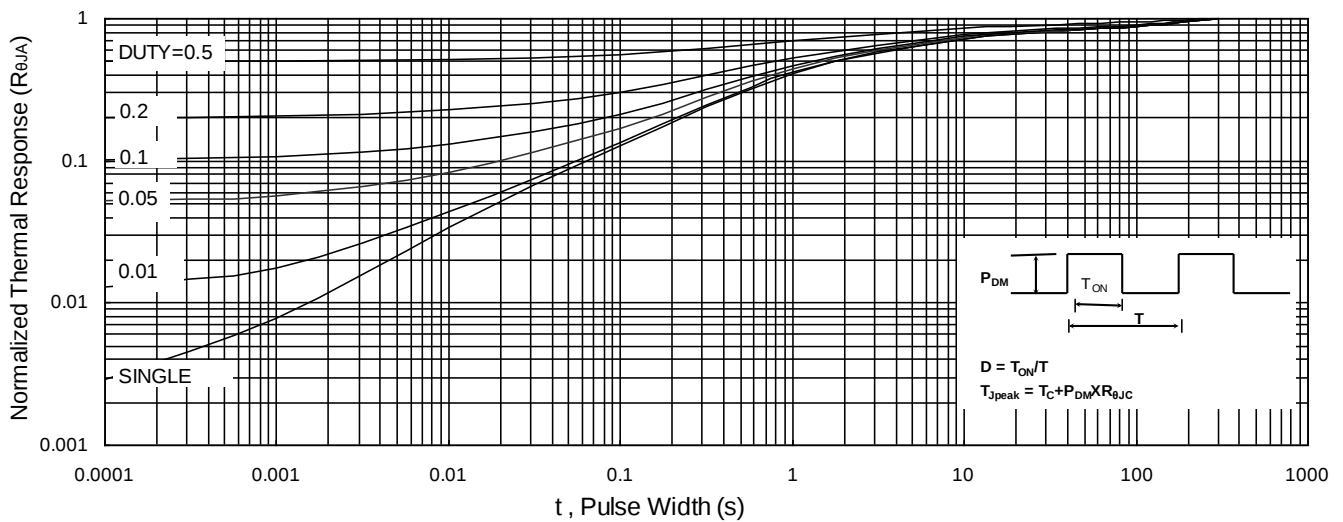


Fig.9 Normalized Maximum Transient Thermal Impedance

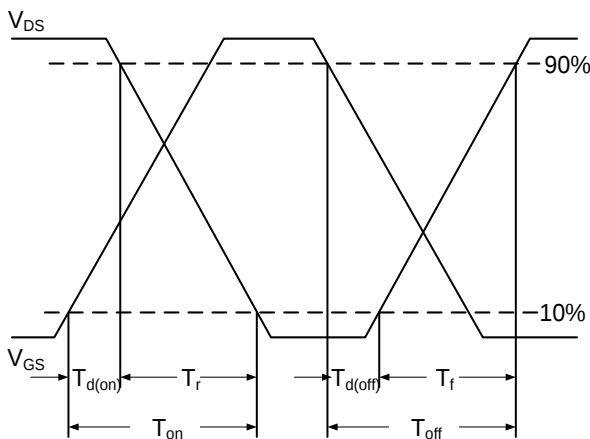


Fig.10 Switching Time Waveform

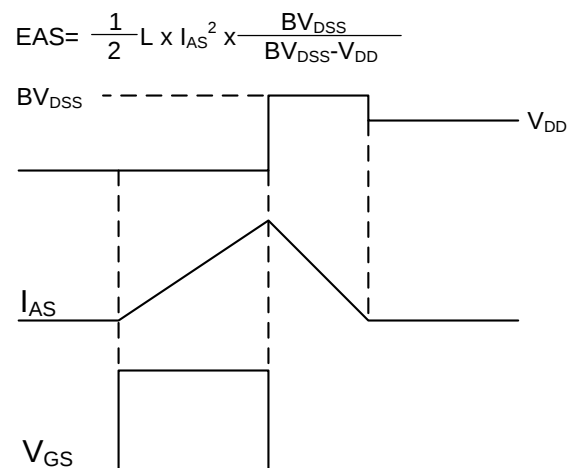


Fig.11 Unclamped Inductive Waveform

➤ P-Channel Typical Characteristics

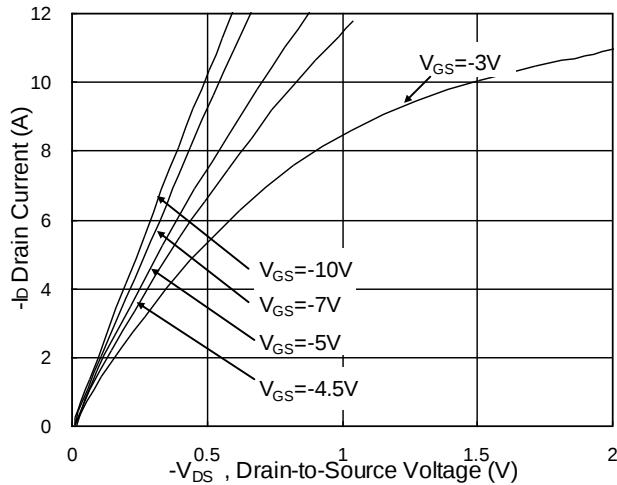


Fig.1 Typical Output Characteristics

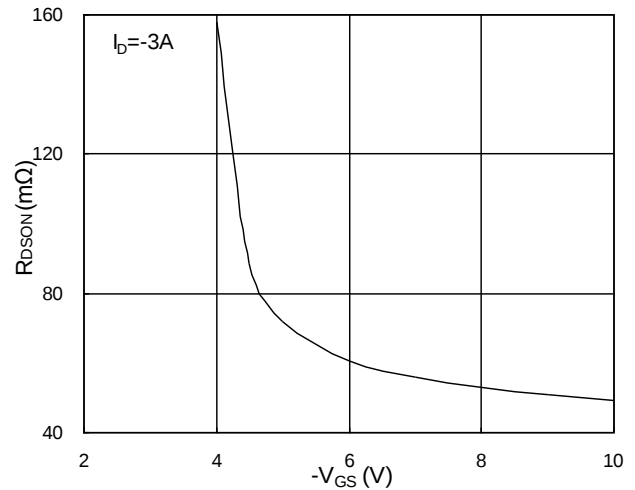


Fig.2 On-Resistance v.s Gate-Source

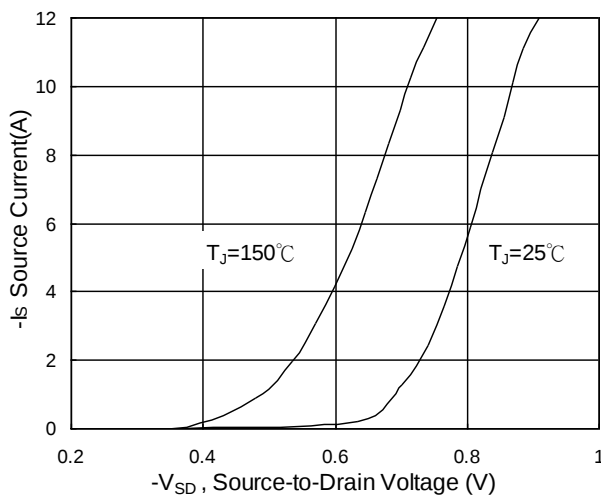


Fig.3 Forward Characteristics of Reverse

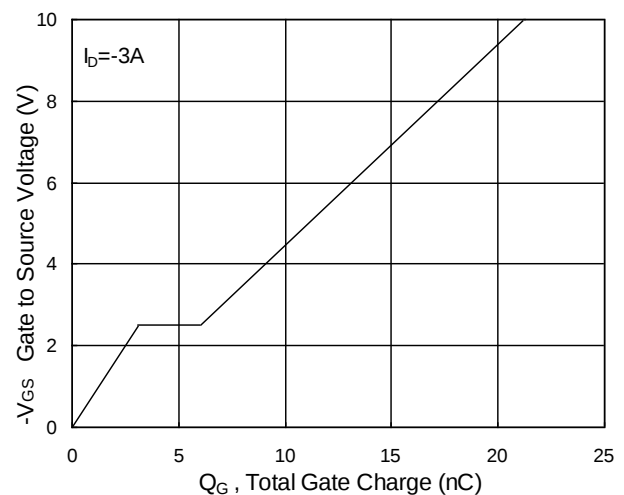


Fig.4 Gate-Charge Characteristics

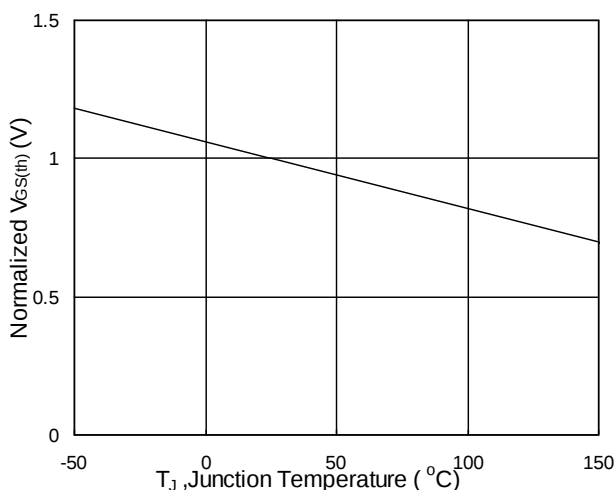


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

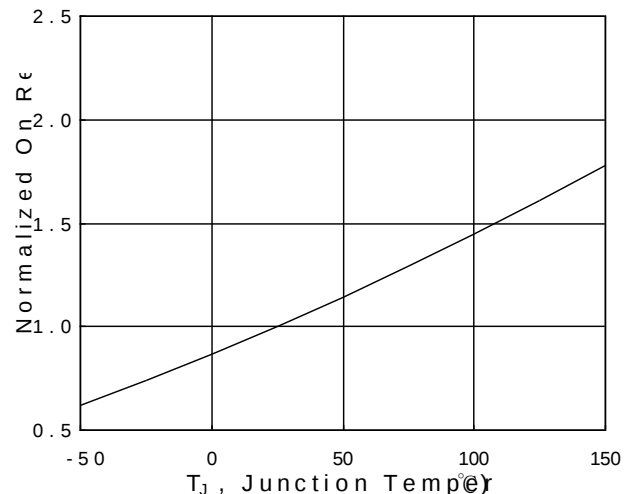


Fig.6 Normalized $R_{DS(ON)}$ v.s T_J

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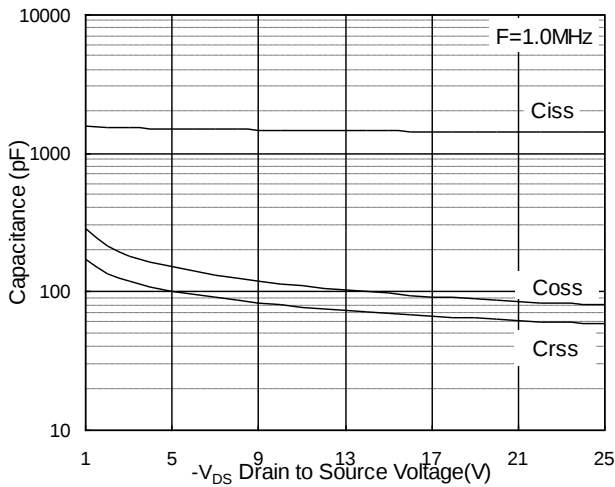


Fig.7 Capacitance

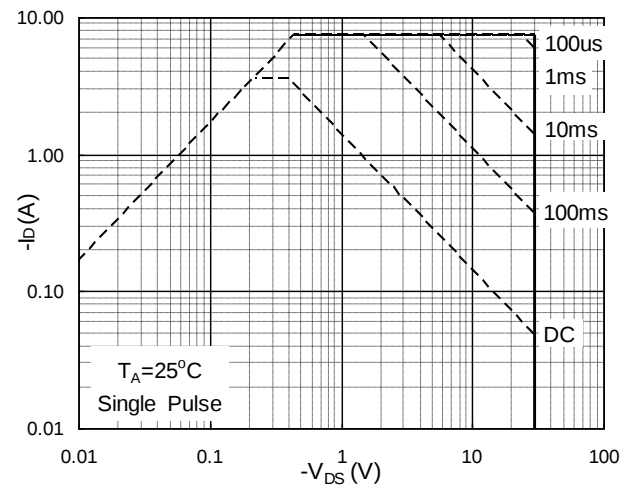


Fig.8 Safe Operating Area

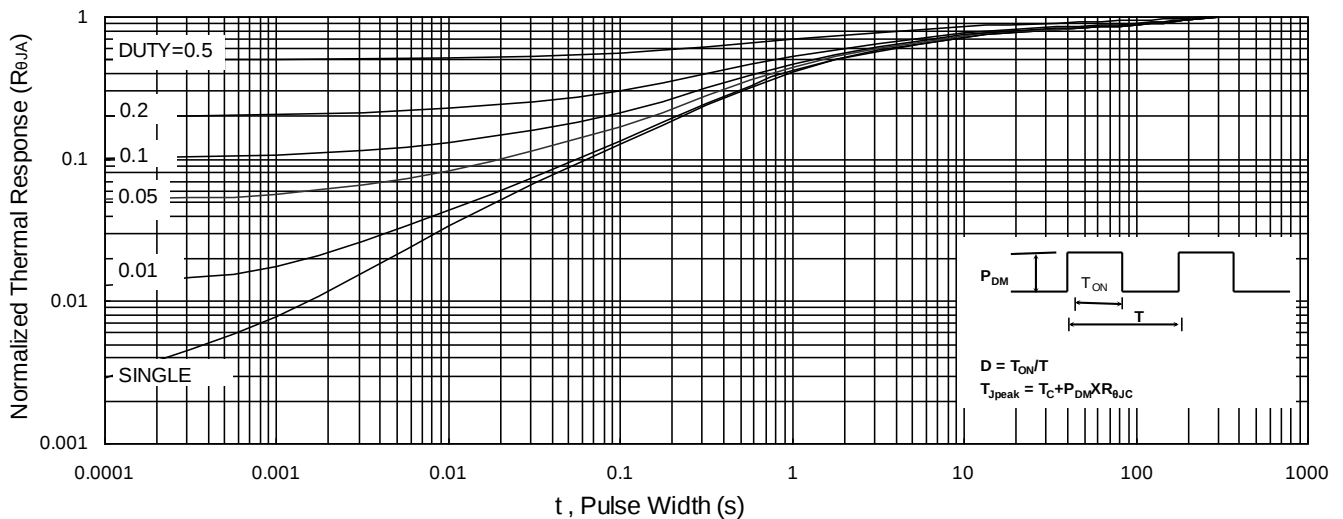


Fig.9 Normalized Maximum Transient Thermal Impedance

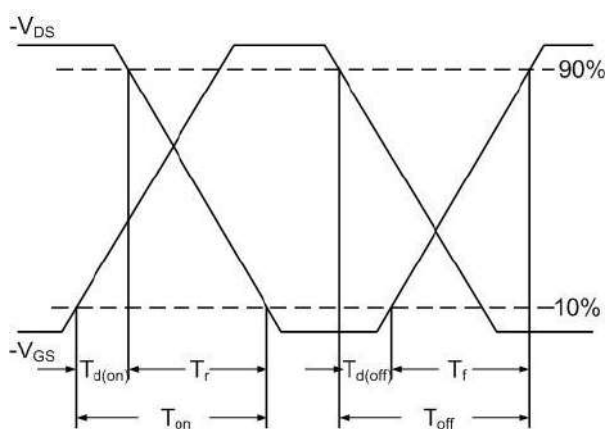


Fig.10 Switching Time Waveform

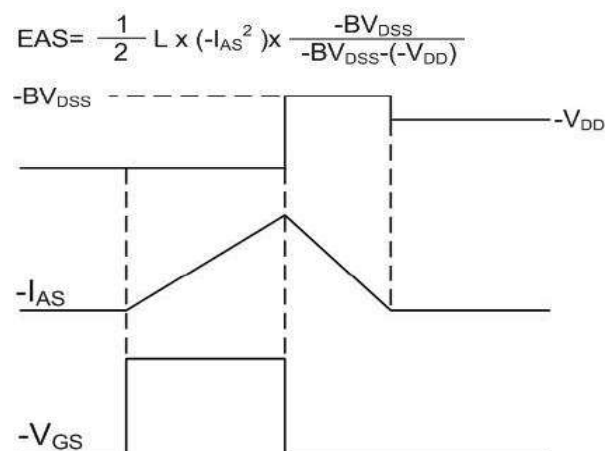
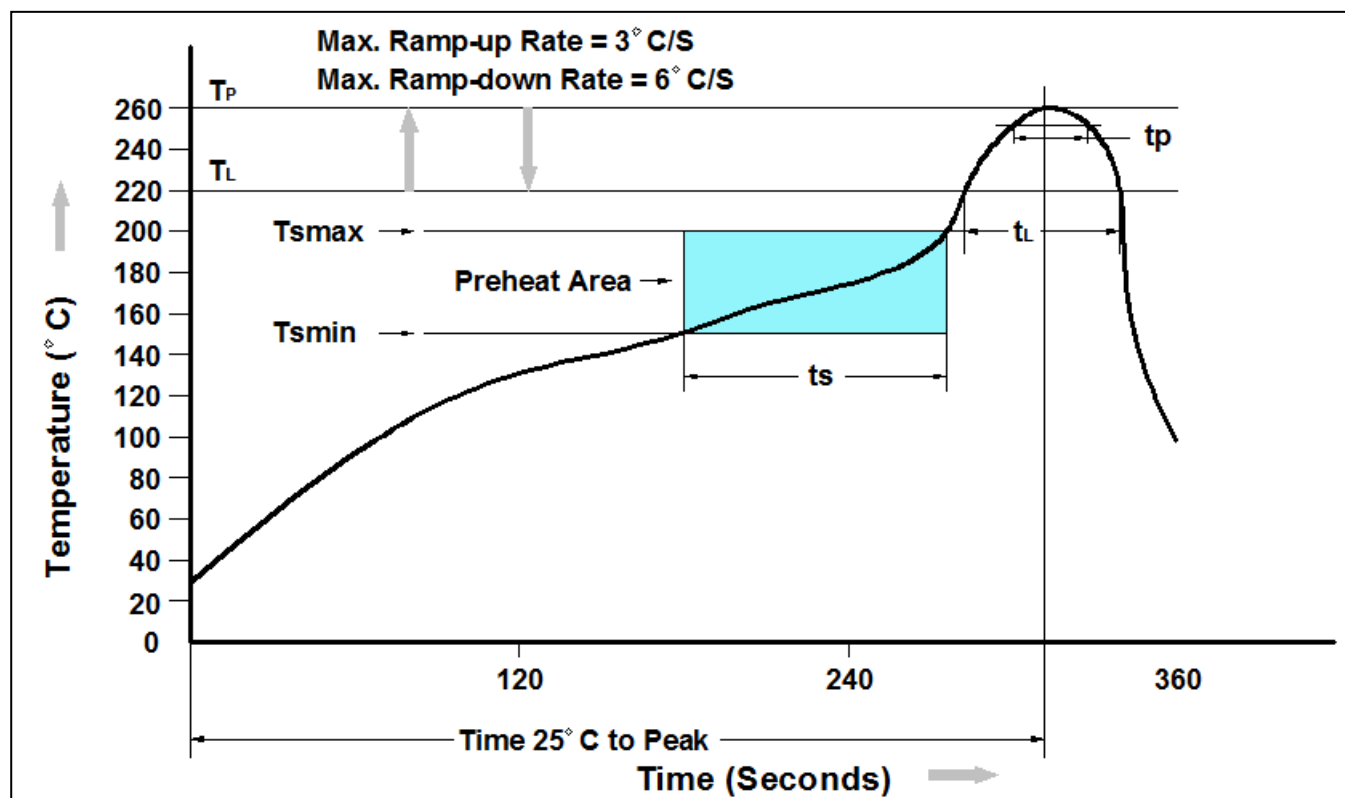


Fig.11 Unclamped Inductive Waveform

➤ Recommend IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	150°C
Temperature Max. (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds
Average Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

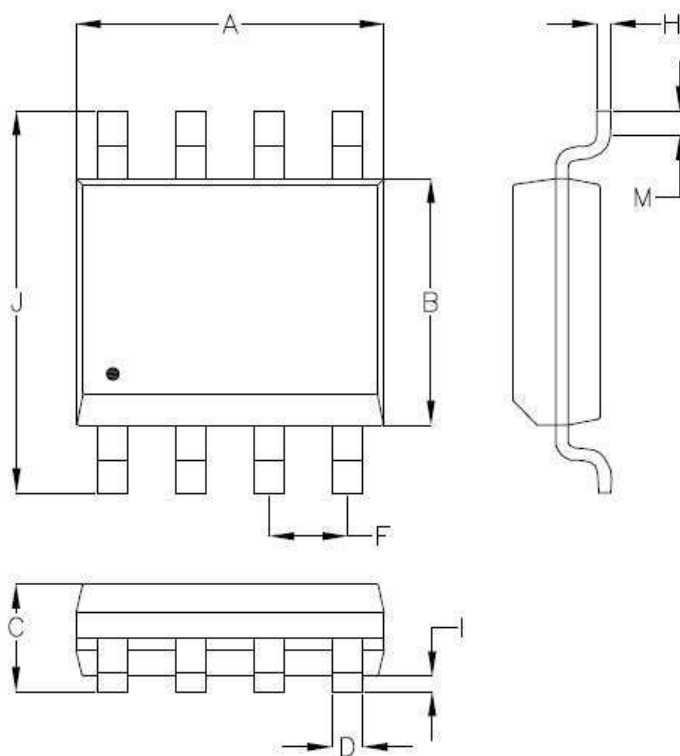
Part Number	Description	Quantity
PAC69TJ01J	SOP-8 Reel	2500 pcs

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➤ Package Information (SOP-8)



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.700	5.150	0.185	0.203
B	3.700	4.100	0.146	0.161
C	1.23	1.753	0.048	0.069
D	0.310	0.510	0.012	0.020
F	1.070	1.470	0.042	0.058
H	0.160	0.254	0.006	0.010
I	0.050	0.254	0.002	0.010
J	5.750	6.250	0.226	0.246
M	0.400	1.270	0.016	0.050

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